Serial No.: 10/519,463

Atty Docket No.: P70333US0

## **AMENDMENTS TO THE TITLE**

## In the Title:

Please replace the title at page 1, line 1 of the specification as follows:

GASKET FOR ELECTRONIC EQUIPMENT A HARD DISC DEVICE

Please replace paragraph on page 5, beginning on line 4 of the Substitute

Specification filed on November 29, 2006, with the following amended paragraph:

In the case that the packing extension portion for partly enlarging the adhesive

bonding area of the packing to the plate is provided in the position close to the screw

fixing portion in the plane shape of the packing or the inflection portion or the

position close thereto in the plane shape of the packing, as in the gasket in accordance

with the first aspect, the second aspect or the third aspect of the present invention

provided with the structure mentioned above, the adhesive bonding area of the

packing to the plate is enlarged in the position in which the packing extension portion

is provided, and an adhesive force is increased. Accordingly, since the adhesive force

of the packing is large even if a comparatively large bending moment or the like is

applied to the packing due to a fastening of the screw or the like, the packing is hard

to be peeled off from the plate. The inflection portion mentioned above is a position

in which the packing is bent or curved or twisted crossed in the plane shape thereof,

and there is an instance that it is provided in a position close to the screw fixing

portion of the plate and an instance where it is provided in another comparatively far

position than the position close to the screw fixing portion.

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